

Data sheet acquired from Harris Semiconductor SCHS046I

CMOS Hex Buffer/Converters

The CD4049UB and CD4050B devices are inverting and non-inverting hex buffers, respectively, and feature logic-level conversion using only one supply voltage (V_{CC}). The input-signal high level (V_{IH}) can exceed the V_{CC} supply voltage when these devices are used for logic-level conversions. These devices are intended for use as CMOS to DTL/TTL converters and can drive directly two DTL/TTL loads. (V_{CC} = 5V, V_{OI} \leq 0.4V, and I_{OI} \geq 3.3mA.)

The CD4049UB and CD4050B are designated as replacements for CD4009UB and CD4010B, respectively. Because the CD4049UB and CD4050B require only one power supply, they are preferred over the CD4009UB and CD4010B and should be used in place of the CD4009UB and CD4010B in all inverter, current driver, or logic-level conversion applications. In these applications the CD4049UB and CD4050B are pin compatible with the CD4009UB and CD4010B respectively, and can be substituted for these devices in existing as well as in new designs. Terminal No. 16 is not connected internally on the CD4049UB or CD4050B, therefore, connection to this terminal is of no consequence to circuit operation. For applications not requiring high sink-current or voltage conversion, the CD4069UB Hex Inverter is recommended.

Features

- CD4049UB Inverting
- CD4050B Non-Inverting
- High Sink Current for Driving 2 TTL Loads
- High-To-Low Level Logic Conversion
- 100% Tested for Quiescent Current at 20V
- Maximum Input Current of 1µA at 18V Over Full Package Temperature Range; 100nA at 18V and 25°C
- 5V, 10V and 15V Parametric Ratings

Applications

- CMOS to DTL/TTL Hex Converter
- · CMOS Current "Sink" or "Source" Driver
- · CMOS High-To-Low Logic Level Converter

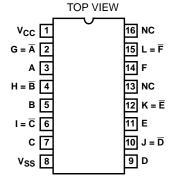
Ordering Information

| PART NUMBER | TEMP. RANGE (^O C) | PACKAGE |
|-------------|----------------------------------|--------------|
| CD4049UBF3A | -55 to 125 | 16 Ld CERDIP |
| CD4050BF3A | -55 to 125 | 16 Ld CERDIP |
| CD4049UBD | -55 to 125 | 16 Ld SOIC |
| CD4049UBDR | -55 to 125 | 16 Ld SOIC |
| CD4049UBDT | -55 to 125 | 16 Ld SOIC |
| CD4049UBDW | -55 to 125 | 16 Ld SOIC |
| CD4049UBDWR | -55 to 125 | 16 Ld SOIC |
| CD4049UBE | -55 to 125 | 16 Ld PDIP |
| CD4049UBNSR | -55 to 125 | 16 Ld SOP |
| CD4049UBPW | -55 to 125 | 16 Ld TSSOP |
| CD4049UBPWR | -55 to 125 | 16 Ld TSSOP |
| CD4050BD | -55 to 125 | 16 Ld SOIC |
| CD4050BDR | -55 to 125 | 16 Ld SOIC |
| CD4050UBDT | -55 to 125 | 16 Ld SOIC |
| CD4050BDW | -55 to 125 | 16 Ld SOIC |
| CD4050BDWR | -55 to 125 | 16 Ld SOIC |
| CD4050BE | -55 to 125 | 16 Ld PDIP |
| CD4050NSR | -55 to 125 | 16 Ld SOP |
| CD4050BPW | -55 to 125 | 16 Ld TSSOP |
| CD4050BPWR | -55 to 125 | 16 Ld TSSOP |

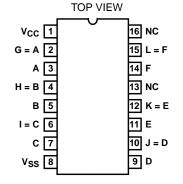
NOTE: When ordering, use the entire part number. The suffix R denotes tape and reel. The suffix T denotes a small-quantity reel of 250.

Pinouts

CD4049UB (PDIP, CERDIP, SOIC, SOP, TSSOP)



CD4050B (PDIP, CERDIP, SOIC, SOP)



Functional Block Diagrams

CD4049UB

A
$$\frac{3}{}$$

B $\frac{5}{}$

C $\frac{7}{}$

G = \overline{A}

B $\frac{5}{}$

G = \overline{A}

B $\frac{5}{}$

G = \overline{A}

G = \overline{A}

D $\frac{9}{}$

G = \overline{A}

D $\frac{4}{}$

H = \overline{B}

G $\frac{10}{}$

G = \overline{C}

D $\frac{9}{}$

D $\frac{10}{}$

J = \overline{D}

E $\frac{11}{}$

O $\frac{12}{}$

K = \overline{E}

V_{CC}

V_{SS}

NC = 13

NC = 16

CD4050B

A
$$\frac{3}{2}$$
 G = A

B $\frac{5}{4}$ H = B

C $\frac{7}{6}$ I = C

D $\frac{9}{10}$ J = D

E $\frac{11}{12}$ K = E

F $\frac{14}{15}$ L = F

V_{CC} $\frac{8}{15}$ NC = 13

NC = 16

Schematic Diagrams

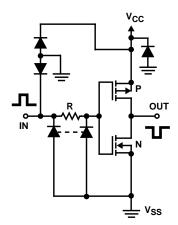


FIGURE 1A. SCHEMATIC DIAGRAM OF CD4049UB, 1 OF 6 IDENTICAL UNITS

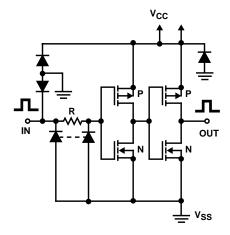


FIGURE 1B. SCHEMATIC DIAGRAM OF CD4050B, 1 OF 6 IDENTICAL UNITS

CD4049UB, CD4050B

Absolute Maximum Ratings

Operating Conditions

Temperature Range -55°C to 125°C

Thermal Information

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE

1. The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

| | | | | LIMITS AT INDICATED TEMPERATURE (°C) | | | | | | | |
|--|--------------------|------------------------|---------------------|--------------------------------------|-------|-------|-------|-------|------|------|-------|
| | TEST CONDITIONS | | | | | | | | 25 | | |
| PARAMETER | V _O (V) | V _{IN} (V) | V _{CC} (V) | -55 | -40 | 85 | 125 | MIN | TYP | MAX | UNITS |
| Quiescent Device Current | - | 0,5 | 5 | 1 | 1 | 30 | 30 | - | 0.02 | 1 | μΑ |
| I _{DD} (Max) | - | 0,10 | 10 | 2 | 2 | 60 | 60 | - | 0.02 | 2 | μΑ |
| | - | 0,15 | 15 | 4 | 4 | 120 | 120 | - | 0.02 | 4 | μΑ |
| | - | 0,20 | 20 | 20 | 20 | 600 | 600 | - | 0.04 | 20 | μΑ |
| Output Low (Sink) Current | 0.4 | 0,5 | 4.5 | 3.3 | 3.1 | 2.1 | 1.8 | 2.6 | 5.2 | - | mA |
| I _{OL} (Min) | 0.4 | 0,5 | 5 | 4 | 3.8 | 2.9 | 2.4 | 3.2 | 6.4 | - | mA |
| | 0.5 | 0,10 | 10 | 10 | 9.6 | 6.6 | 5.6 | 8 | 16 | - | mA |
| | 1.5 | 0,15 | 15 | 26 | 25 | 20 | 18 | 24 | 48 | - | mA |
| Output High (Source) Current | 4.6 | 0,5 | 5 | -0.81 | -0.73 | -0.58 | -0.48 | -0.65 | -1.2 | - | mA |
| I _{OH} (Min) | 2.5 | 0,5 | 5 | -2.6 | -2.4 | -1.9 | -1.55 | -2.1 | -3.9 | - | mA |
| | 9.5 | 0,10 | 10 | -2.0 | -1.8 | -1.35 | -1.18 | -1.65 | -3.0 | - | mA |
| | 13.5 | 0,15 | 15 | -5.2 | -4.8 | -3.5 | -3.1 | -4.3 | -8.0 | - | mA |
| Out Voltage Low Level | - | 0,5 | 5 | 0.05 | 0.05 | 0.05 | 0.05 | - | 0 | 0.05 | V |
| V _{OL} (Max) | - | 0,10 | 10 | 0.05 | 0.05 | 0.05 | 0.05 | - | 0 | 0.05 | V |
| | - | 0,15 | 15 | 0.05 | 0.05 | 0.05 | 0.05 | - | 0 | 0.05 | V |
| Output Voltage High Level | - | 0,5 | 5 | 4.95 | 4.95 | 4.95 | 4.95 | 4.95 | 5 | - | V |
| V _{OH} (Min) | - | 0,10 | 10 | 9.95 | 9.95 | 9.95 | 9.95 | 9.95 | 10 | - | V |
| | - | 0,15 | 15 | 14.95 | 14.95 | 14.95 | 14.95 | 14.95 | 15 | - | V |
| Input Low Voltage, V _{IL} (Max) | 4.5 | - | 5 | 1 | 1 | 1 | 1 | - | - | 1 | V |
| CD4049UB | 9 | - | 10 | 2 | 2 | 2 | 2 | - | - | 2 | V |
| | 13.5 | - | 15 | 2.5 | 2.5 | 2.5 | 2.5 | - | - | 2.5 | V |
| Input Low Voltage, V _{IL} (Max) | 0.5 | - | 5 | 1.5 | 1.5 | 1.5 | 1.5 | - | - | 1.5 | V |
| CD4050B | 1 | - | 10 | 3 | 3 | 3 | 3 | - | - | 3 | V |
| | 1.5 | - | 15 | 4 | 4 | 4 | 4 | - | - | 4 | V |

CD4049UB, CD4050B

DC Electrical Specifications (Continued)

| | | | | LIMITS AT INDICATED TEMPERATURE (°C) | | | | | | | |
|---|--------------------|------------------------|---------------------|--------------------------------------|------|------|------|------|-------------------|------|-------|
| | TES | TEST CONDITIONS | | | | | | 25 | | | |
| PARAMETER | V _O (V) | V _{IN} (V) | V _{CC} (V) | -55 | -40 | 85 | 125 | MIN | TYP | MAX | UNITS |
| Input High Voltage, V _{IH} Min | 0.5 | - | 5 | 4 | 4 | 4 | 4 | 4 | - | - | V |
| CD4049UB | 1 | - | 10 | 8 | 8 | 8 | 8 | 8 | - | - | V |
| | 1.5 | - | 15 | 12.5 | 12.5 | 12.5 | 12.5 | 12.5 | - | - | V |
| Input High Voltage, V _{IH} Min | 4.5 | - | 5 | 3.5 | 3.5 | 3.5 | 3.5 | 3.5 | - | - | V |
| CD4050B | 9 | - | 10 | 7 | 7 | 7 | 7 | 7 | - | - | V |
| | 13.5 | - | 15 | 11 | 11 | 11 | 11 | 11 | - | - | V |
| Input Current, I _{IN} Max | - | 0,18 | 18 | ±0.1 | ±0.1 | ±1 | ±1 | - | ±10 ⁻⁵ | ±0.1 | μΑ |

AC Electrical Specifications $T_A = 25^{o}C$, Input t_r , $t_f = 20$ ns, $C_L = 50$ pF, $R_L = 200$ k Ω

| | TEST CO | NDITIONS | LIMITS (ALL | LIMITS (ALL PACKAGES) | | |
|---|-----------------|-----------------|-------------|-----------------------|-------|--|
| PARAMETER | V _{IN} | v _{cc} | TYP | MAX | UNITS | |
| Propagation Delay Time | 5 | 5 | 60 | 120 | ns | |
| Low to High, t _{PLH} CD4049UB | 10 | 10 | 32 | 65 | ns | |
| | 10 | 5 | 45 | 90 | ns | |
| | 15 | 15 | 25 | 50 | ns | |
| | 15 | 5 | 45 | 90 | ns | |
| Propagation Delay Time | 5 | 5 | 70 | 140 | ns | |
| Low to High, t _{PLH} CD4050B | 10 | 10 | 40 | 80 | ns | |
| | 10 | 5 | 45 | 90 | ns | |
| | 15 | 15 | 30 | 60 | ns | |
| | 15 | 5 | 40 | 80 | ns | |
| Propagation Delay Time High to Low, t _{PHL} CD4049UB | 5 | 5 | 32 | 65 | ns | |
| | 10 | 10 | 20 | 40 | ns | |
| | 10 | 5 | 15 | 30 | ns | |
| | 15 | 15 | 15 | 30 | ns | |
| | 15 | 5 | 10 | 20 | ns | |
| Propagation Delay Time | 5 | 5 | 55 | 110 | ns | |
| High to Low, t _{PHL} CD4050B | 10 | 10 | 22 | 55 | ns | |
| | 10 | 5 | 50 | 100 | ns | |
| | 15 | 15 | 15 | 30 | ns | |
| | 15 | 5 | 50 | 100 | ns | |
| Transition Time, Low to High, t _{TLH} | 5 | 5 | 80 | 160 | ns | |
| | 10 | 10 | 40 | 80 | ns | |
| | 15 | 15 | 30 | 60 | ns | |
| Transition Time, High to Low, t _{THL} | 5 | 5 | 30 | 60 | ns | |
| | 10 | 10 | 20 | 40 | ns | |
| | 15 | 15 | 15 | 30 | ns | |

AC Electrical Specifications $T_A = 25^{o}C$, Input t_r , $t_f = 20$ ns, $C_L = 50$ pF, $R_L = 200$ k Ω (Continued)

| | TEST CO | NDITIONS | LIMITS (ALL | | |
|--|-----------------|-----------------|-------------|------|-------|
| PARAMETER | V _{IN} | V _{CC} | TYP | MAX | UNITS |
| Input Capacitance, C _{IN} CD4049UB | - | - | 15 | 22.5 | pF |
| Input Capacitance, C _{IN} CD4050B | - | - | 5 | 7.5 | pF |

Typical Performance Curves

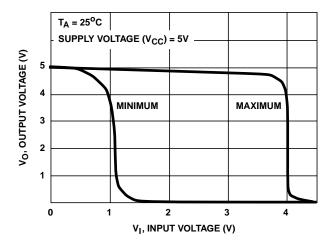


FIGURE 2. MINIMUM AND MAXIMUM VOLTAGE TRANSFER CHARACTERISTICS FOR CD4049UB

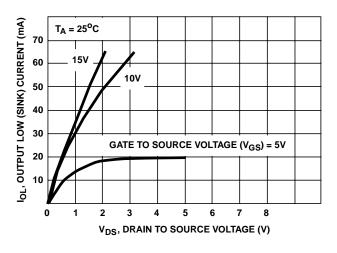


FIGURE 4. TYPICAL OUTPUT LOW (SINK) CURRENT CHARACTERISTICS

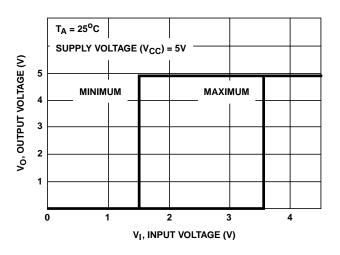


FIGURE 3. MINIMUM AND MAXIMUM VOLTAGE TRANSFER CHARACTERISTICS FOR CD4050B

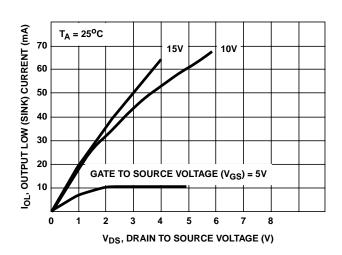


FIGURE 5. MINIMUM OUTPUT LOW (SINK) CURRENT DRAIN CHARACTERISTICS

Typical Performance Curves (Continued)

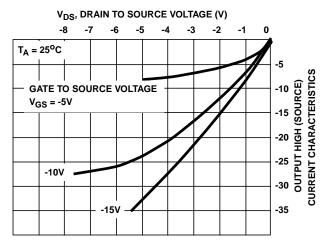


FIGURE 6. TYPICAL OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

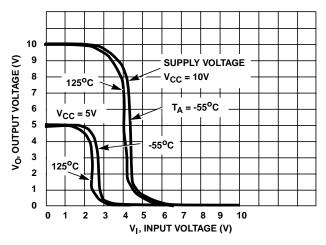


FIGURE 8. TYPICAL VOLTAGE TRANSFER CHARACTERISTICS
AS A FUNCTION OF TEMPERATURE FOR CD4049UB

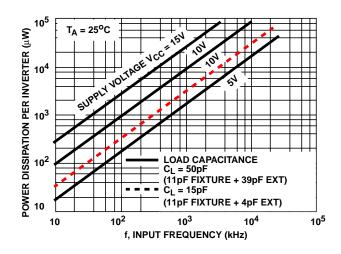


FIGURE 10. TYPICAL POWER DISSIPATION vs FREQUENCY CHARACTERISTICS

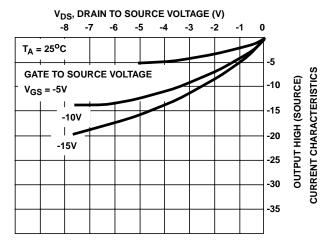


FIGURE 7. MINIMUM OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

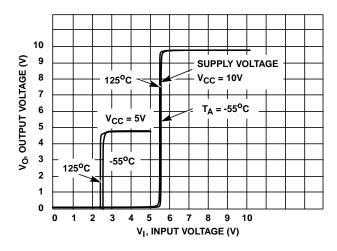


FIGURE 9. TYPICAL VOLTAGE TRANSFER CHARACTERISTICS
AS A FUNCTION OF TEMPERATURE FOR CD4050B

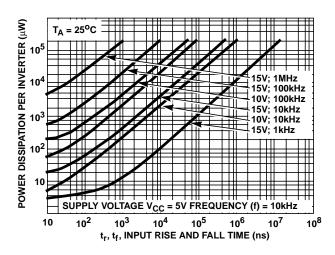


FIGURE 11. TYPICAL POWER DISSIPATION VS INPUT RISE
AND FALL TIMES PER INVERTER FOR CD4049UB

Typical Performance Curves (Continued)

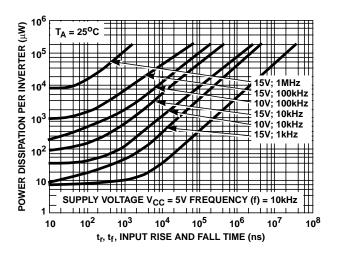


FIGURE 12. TYPICAL POWER DISSIPATION VS INPUT RISE AND FALL TIMES PER INVERTER FOR CD4050B

Test Circuits

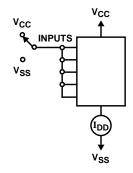
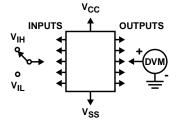
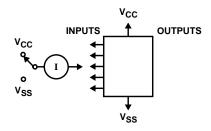


FIGURE 13. QUIESCENT DEVICE CURRENT TEST CIRCUIT



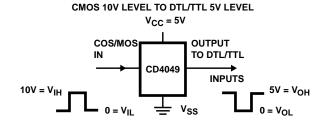
NOTE: Test any one input with other inputs at V_{CC} or V_{SS} .

FIGURE 14. INPUT VOLTAGE TEST CIRCUIT



NOTE: Measure inputs sequentially, to both V_{CC} and V_{SS} connect all unused inputs to either V_{CC} or V_{SS} .

FIGURE 15. INPUT CURRENT TEST CIRCUIT

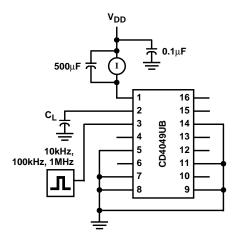


In Terminal - 3, 5, 7, 9, 11, or 14 Out Terminal - 2, 4, 6, 10, 12 or 15

V_{CC} Terminal - 1 V_{SS} Terminal - 8

FIGURE 16. LOGIC LEVEL CONVERSION APPLICATION

Test Circuits (Continued)



C_L INCLUDES FIXTURE CAPACITANCE

FIGURE 17. DYNAMIC POWER DISSIPATION TEST CIRCUITS



PACKAGING INFORMATION

| CD4049UBDR ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-1-236C-UNLIM Lev | Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|--|------------------|-----------------------|-----------------|--------------------|------|----------------|--------------|------------------|--|
| CD4049UBDT ACTIVE SOIC D 16 250 Pb-Free CU NIPDAU Level-1-235C-UNLIM CD4049UBDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-1-235C-UNLIM CD4049UBDWR ACTIVE SOIC DW 16 2000 Pb-Free CU NIPDAU Level-1-235C-UNLIM CD4049UBDWR ACTIVE SOIC DW 16 2000 Pb-Free CU NIPDAU Level-1-235C-UNLIM CD4049UBF ACTIVE PDIP N 16 25 Pb-Free CU NIPDAU Level-1-235C-UNLIM CD4049UBF ACTIVE CDIP J 16 TBD Call TI Level-NC-NC-NC CD4049UBF ACTIVE CDIP J 16 TBD Call TI Level-NC-NC-NC CD4049UBF ACTIVE CDIP J 16 TBD Call TI Level-NC-NC-NC-NC CD4049UBM OBSOLETE SOIC D 16 TBD Call TI CD4049UBM OBSOLETE SOIC D 16 TBD Call TI Call TI CD4049UBM ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-1-235C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2500 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4050BDR ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4050BDW ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4050BDW ACTIVE SOIC DW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4050BDWR ACTIVE S | CD4049UBD | ACTIVE | SOIC | D | 16 | 40 | | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| CD4049UBDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2250C-I YEAR Level-1-235C-UNLIM Level-1-235C-UNLIM Level-1-250C-INLIM Level-NC-NC-NC RoHS Level-1-250C-INLIM Level-NC-NC-NC RoHS Level-1-250C-INLIM Level-NC-NC-NC Level- | CD4049UBDR | ACTIVE | SOIC | D | 16 | 2500 | | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| CD4049UBDWR | CD4049UBDT | ACTIVE | SOIC | D | 16 | 250 | | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| CD4049UBE ACTIVE PDIP N 16 25 Pb-Free CU NIPDAU Level-NC-NC-NC CD4049UBF ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC CD4049UBF3A ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC CD4049UBMA OBSOLETE SOIC D 16 TBD Call TI Call TI Call TI CD4049UBM96 OBSOLETE SOIC D 16 TBD Call TI Call TI Call TI CD4049UBM96 OBSOLETE SOIC D 16 TBD Call TI Call TI CD4049UBM96 OBSOLETE SOIC D 16 TBD Call TI Call TI CD4049UBM97 ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-2-260C-1 YEAR Level-1-250C-UNLIM CD4049UBPW ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWRE4 ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWRE4 ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-2-260C-1 YEAR CROHS) CD4050BD ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-2-260C-1 YEAR CROHS) CD4050BD ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-2-250C-1 YEAR CROHS) CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE | CD4049UBDW | ACTIVE | SOIC | DW | 16 | 40 | | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| CD4049UBF | CD4049UBDWR | ACTIVE | SOIC | DW | 16 | 2000 | | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| CD4049UBF3A ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC CD4049UBM OBSOLETE SOIC D 16 TBD Call TI Call TI CD4049UBM96 OBSOLETE SOIC D 16 TBD Call TI Call TI CD4049UBNSR ACTIVE SO NS 16 2000 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4049UBPW ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM (RoHS) CD4049UBPWR4 ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM (RoHS) CD4049UBPWR4 ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM (RoHS) CD4049UBPWR4 ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM (RoHS) CD4050BD ACTIVE SOIC D 16 40 Pb-Free CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4050BDR ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 2000 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 2000 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM Level | CD4049UBE | ACTIVE | PDIP | N | 16 | 25 | | CU NIPDAU | Level-NC-NC-NC |
| CD4049UBM OBSOLETE SOIC D 16 TBD Cail TI Cail TI CD4049UBM96 OBSOLETE SOIC D 16 TBD Call TI Call TI CD4049UBNSR ACTIVE SO NS 16 2000 Pb-Free (RoHS) CU NIPDAU Level-2260C-1 YEAR (ROHS) CD4049UBPW ACTIVE TSSOP PW 16 90 Pb-Free (ROHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (ROHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free (ROHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWRE4 ACTIVE TSSOP PW 16 2000 Pb-Free (ROHS) CU NIPDAU Level-1-250C-UNLIM CD4050BD ACTIVE SOIC D 16 2500 Pb-Free (ROHS) CU NIPDAU Level-1-235C-UNLIM CD4050BDT ACTIVE SOIC D 16 | CD4049UBF | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| CD4049UBM96 OBSOLETE SOIC D 16 TBD Call TI Call TI CD4049UBNSR ACTIVE SO NS 16 2000 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR (Evel-1-235C-UNLIM CD4049UBPW ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWRE4 ACTIVE TSSOP PW 16 2000 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4050BD ACTIVE SOIC D 16 40 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4050BDR ACTIVE SOIC D 16 250 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR (Level-1-235C-UNLIM CD4050BDW AC | CD4049UBF3A | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| CD4049UBNSR ACTIVE SO NS 16 2000 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4049UBPW ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWR4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWRE4 ACTIVE TSSOP PW 16 2000 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4049UBPWRE4 ACTIVE TSSOP PW 16 2000 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4050BD ACTIVE SOIC D 16 40 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4050BDR ACTIVE SOIC D 16 2500 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC D 16 250 Pb-Free (RoHS) CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM <td>CD4049UBM</td> <td>OBSOLETE</td> <td>SOIC</td> <td>D</td> <td>16</td> <td></td> <td>TBD</td> <td>Call TI</td> <td>Call TI</td> | CD4049UBM | OBSOLETE | SOIC | D | 16 | | TBD | Call TI | Call TI |
| CD4049UBPW ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM (RoHS) CD4049UBPWR ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWRE4 ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4049UBPWRE4 ACTIVE TSSOP PW 16 2000 Pb-Free CU NIPDAU Level-1-250C-UNLIM CD4050BD ACTIVE SOIC D 16 40 Pb-Free CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM Level-1-235C-UNLIM CD4050BDR ACTIVE SOIC D 16 2500 Pb-Free CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM Level-1-235C-UNLIM Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM Level-1-235C-UNLIM CD4050BDWR ACTIVE SOIC DW 16 40 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM Level-1-235C-UNLIM CD4050BDWR ACTIVE SOIC DW 16 2000 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM Level-1-235C-UNLIM CD4050BDWR ACTIVE SOIC DW 16 2000 Pb-Free CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM Le | CD4049UBM96 | OBSOLETE | SOIC | D | 16 | | TBD | Call TI | Call TI |
| CD4049UBPWE4 | CD4049UBNSR | ACTIVE | so | NS | 16 | 2000 | | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| CD4049UBPWR | CD4049UBPW | ACTIVE | TSSOP | PW | 16 | 90 | | CU NIPDAU | Level-1-250C-UNLIM |
| CD4049UBPWRE4 | CD4049UBPWE4 | ACTIVE | TSSOP | PW | 16 | 90 | | CU NIPDAU | Level-1-250C-UNLIM |
| CD4050BD | CD4049UBPWR | ACTIVE | TSSOP | PW | 16 | 2000 | | CU NIPDAU | Level-1-250C-UNLIM |
| CD4050BDR ACTIVE SOIC D 16 2500 Pb-Free (RoHS) Level-1-235C-UNLIM Level-1-235C-UNLIM Level-1-235C-UNLIM CD4050BDT ACTIVE SOIC D 16 250 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR (RoHS) Level-1-235C-UNLIM Level-2-250C-1 YEAR (RoHS) CU NIPDAU Level-2-250C-1 YEAR (RoHS) Level-1-235C-UNLIM Level-1-235C-UNLIM Level-1-235C-UNLIM CD4050BDWR ACTIVE SOIC DW 16 2000 Pb-Free (RoHS) CU NIPDAU Level-2-250C-1 YEAR (RoHS) Level-1-235C-UNLIM Level-1 | CD4049UBPWRE4 | ACTIVE | TSSOP | PW | 16 | 2000 | | CU NIPDAU | Level-1-250C-UNLIM |
| CD4050BDR ACTIVE SOIC D 16 2500 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4050BDT ACTIVE SOIC D 16 250 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free (RoHS) CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BDWR ACTIVE SOIC DW 16 2000 Pb-Free (RoHS) CU NIPDAU Level-2-250C-1 YEAR Level-1-235C-UNLIM CD4050BE ACTIVE PDIP N 16 25 Pb-Free (RoHS) CU NIPDAU Level-1-235C-UNLIM CD4050BF ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC CD4050BF3A ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC CD4050BNSR ACTIVE SO NS 16 2000 Pb-Free (RoHS) CU NIPDAU | CD4050BD | ACTIVE | SOIC | D | 16 | 40 | | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| CD4050BDW ACTIVE SOIC DW 16 40 Pb-Free (RoHS) Level-1-235C-UNLIM Level-NC-NC-NC CD4050BF ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC CD4050BM OBSOLETE SOIC D 16 TBD Call TI Level-NC-NC-NC CD4050BNSR ACTIVE SO NS 16 2000 Pb-Free (RoHS) Level-1-235C-UNLIM Level-1-235C-UNLIM CD4050BPW ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM Level-1-2 | CD4050BDR | ACTIVE | SOIC | D | 16 | 2500 | Pb-Free | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| CD4050BDWR | CD4050BDT | ACTIVE | SOIC | D | 16 | 250 | | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| CD4050BE | CD4050BDW | ACTIVE | SOIC | DW | 16 | 40 | | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| CD4050BF | CD4050BDWR | ACTIVE | SOIC | DW | 16 | 2000 | | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| CD4050BF ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC CD4050BF3A ACTIVE CDIP J 16 1 TBD Call TI Level-NC-NC-NC CD4050BM OBSOLETE SOIC D 16 TBD Call TI Call TI CD4050BNSR ACTIVE SO NS 16 2000 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4050BPW ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM CD4050BPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM | CD4050BE | ACTIVE | PDIP | N | 16 | 25 | | CU NIPDAU | Level-NC-NC-NC |
| CD4050BM OBSOLETE SOIC D 16 TBD Call TI Call TI CD4050BNSR ACTIVE SO NS 16 2000 Pb-Free (RoHS) CU NIPDAU Level-2-260C-1 YEAR Level-1-235C-UNLIM CD4050BPW ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM (RoHS) CD4050BPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CU NIPDAU Level-1-250C-UNLIM (RoHS) | CD4050BF | ACTIVE | CDIP | J | 16 | 1 | | Call TI | Level-NC-NC-NC |
| CD4050BNSR ACTIVE SO NS 16 2000 Pb-Free CU NIPDAU Level-2-260C-1 YEAR (RoHS) CD4050BPW ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CD4050BPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CD4050BPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) | CD4050BF3A | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| CD4050BPW ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CD4050BPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) CD4050BPWE4 ACTIVE TSSOP PW 16 90 Pb-Free (RoHS) | CD4050BM | OBSOLETE | SOIC | D | 16 | | TBD | Call TI | Call TI |
| (RoHS) CD4050BPWE4 ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-1-250C-UNLIM (RoHS) | CD4050BNSR | ACTIVE | SO | NS | 16 | 2000 | | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| CD4050BPWE4 ACTIVE TSSOP PW 16 90 Pb-Free CU NIPDAU Level-1-250C-UNLIM (RoHS) | CD4050BPW | ACTIVE | TSSOP | PW | 16 | 90 | Pb-Free | CU NIPDAU | Level-1-250C-UNLIM |
| | CD4050BPWE4 | ACTIVE | TSSOP | PW | 16 | 90 | Pb-Free | CU NIPDAU | Level-1-250C-UNLIM |
| | CD4050BPWR | ACTIVE | TSSOP | PW | 16 | 2000 | Pb-Free | CU NIPDAU | Level-1-250C-UNLIM |



PACKAGE OPTION ADDENDUM

6-May-2005

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins I | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|--------|----------------|-------------------------|------------------|------------------------------|
| | | | | | | (RoHS) | | |
| CD4050BPWRE4 | ACTIVE | TSSOP | PW | 16 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| JM38510/05553BEA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |
| JM38510/05554BEA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Level-NC-NC-NC |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



DW (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AA.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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